

20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max @ T _A = 25°C (Note 4)
-20V	495 m $Ω$ @ $V_{GS} = -4.5$ V	-0.59A
	690mΩ @ V _{GS} = -2.5V	-0.50A
	960mΩ @ V _{GS} = -1.8V	-0.42A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Portable electronics

Features and Benefits

- Footprint of just 3mm² less than half the size of SOT23
- 0.8mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- **ESD Protected Gate 3KV**
- Totally Lead-Free & Fully RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208
- Weight: 0.002 grams (approximate)



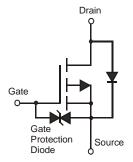


SOT523



D

Top View Internal Schematic



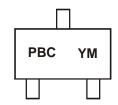
Equivalent Circuit

Ordering Information (Note 3)

ſ	Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
١	DMP21D0UT-7	PBC	7	8	3,000

- Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.
 - 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
 - 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



PBC = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Cha	aracteristic		Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current	Steady State	$T_A = 25$ °C (Note 4) $T_A = 85$ °C (Note 4) $T_A = 25$ °C (Note 5)	I _D	-0.59 -0.42 -0.65	А
Pulsed Drain Current (Note 6)			I _{DM}	-5.0	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P _D	0.24	W
Power Dissipation (Note 5)	P _D	0.33	W
Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	525	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	R ₀ JA	383	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
- 5. Device mounted on 25mm X 25mm FR-4 PCB with high coverage of 2oz copper
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

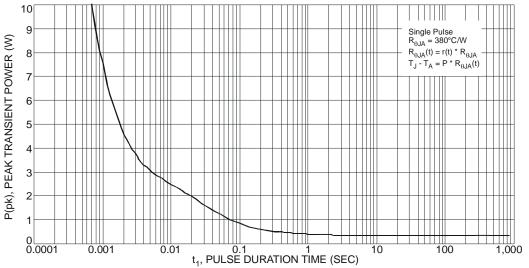
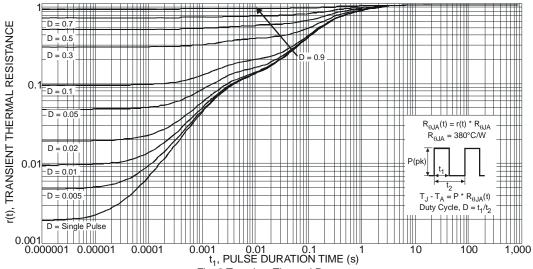


Fig. 1 Single Pulse Maximum Power Dissipation

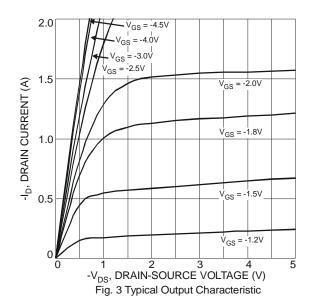


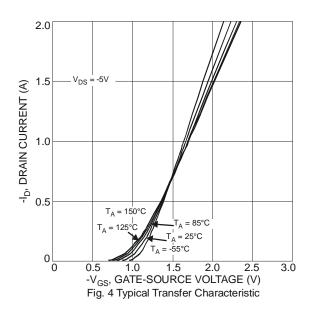


Electrical Characteristics @T_A = 25°C unless otherwise specified

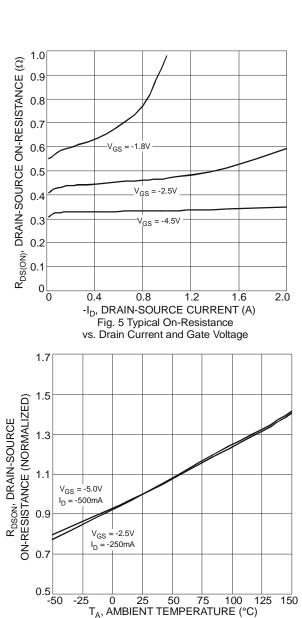
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	•	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	1	-1	μΑ	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						_	
Gate Threshold Voltage	V _{GS(th)}	-	-0.7	-	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
				495		$V_{GS} = -4.5V$, $I_D = -400mA$	
Static Drain-Source On-Resistance	R _{DS} (ON)	-	-	690	mΩ	$V_{GS} = -2.5V$, $I_D = -300mA$	
				960		$V_{GS} = -1.8V, I_D = -100mA$	
Forward Transfer Admittance	Y _{fs}	50	-	-	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	V_{SD}	-	1	-1.2	٧	$V_{GS} = 0V, I_{S} = -300mA$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	-	76.5	-	pF	101/11/101/	
Output Capacitance	Coss	-	13.7	-	pF	$V_{DS} = -10V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	10.7	-	рF	1 – 1.01/11/12	
Gate Resistance	R_g	-	195	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g		1.5	-	nC	$V_{GS} = -8V, V_{DS} = -15V, I_D = -1A$	
Total Gate Charge	Qg	-	1.0	-	nC)/ 45\/\)/ 45\/	
Gate-Source Charge	Q_{gs}	-	0.2	-	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$	
Gate-Drain Charge	Q_{gd}	-	0.3	-	nC	I _D = -1A	
Turn-On Delay Time	t _{D(on)}	-	7.1	-	ns		
Turn-On Rise Time	t _r	-	8.0	-	ns	$V_{DS} = -10V, -I_{D} = 1A$	
Turn-Off Delay Time	t _{D(off)}	-	31.7	-	ns	$V_{GS} = -4.5V$, $R_G = 6\Omega$	
Turn-Off Fall Time	t _f	-	18.5	-	ns		

Notes: 7. Short duration pulse test used to minimize self-heating effect.









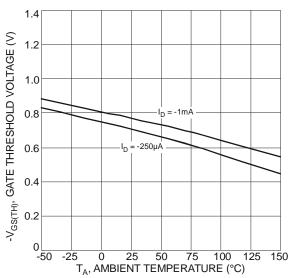
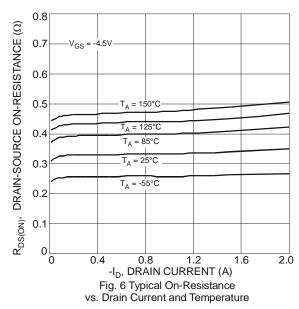
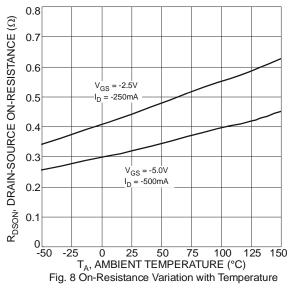
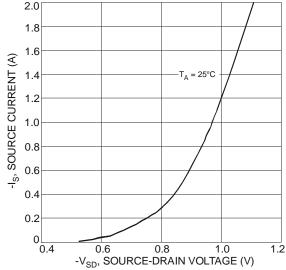


Fig. 7 On-Resistance Variation with Temperature

Fig. 9 Gate Threshold Variation vs. Ambient Temperature









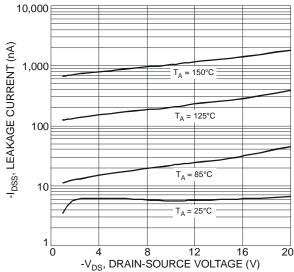
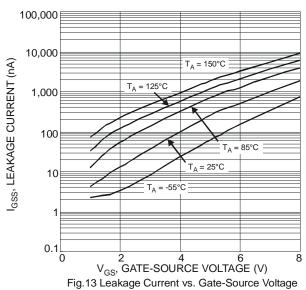
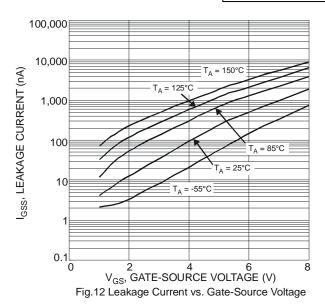
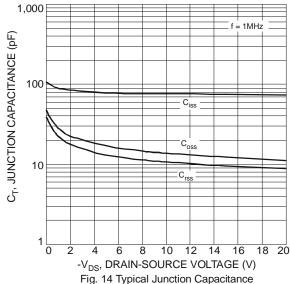


Fig. 11 Typical Leakage Current vs. Drain-Source Voltage

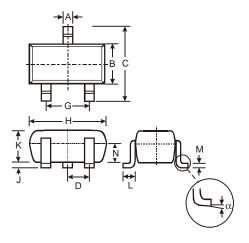






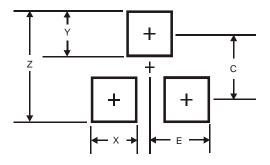


Package Outline Dimensions



	SOT523							
Dim	Min	Max	Тур					
Α	0.15	0.30	0.22					
В	0.75	0.85	0.80					
С	1.45	1.75	1.60					
D	_	_	0.50					
G	0.90	1.10	1.00					
Н	1.50	1.70	1.60					
J	0.00	0.10	0.05					
K	0.60	0.80	0.75					
L	0.10	0.30	0.22					
M	0.10	0.20	0.12					
N	0.45	0.65	0.50					
α	0°	8°	_					
All	All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
E	0.7





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